8080A SYSTEM CONTROLLER AND BUS DRIVER

DESCRIPTION

The μPB8228/8238 is a single chip controller and bus driver for 8080A based systems. All the required interface signals necessary to connect RAM, ROM and I/O components to a μPD8080A are generated.

The μPB8228/8238 provides a bi-directional three-state bus driver for high TTL fan-out and isolation of the processor data bus from the system data bus for increased noise immunity.

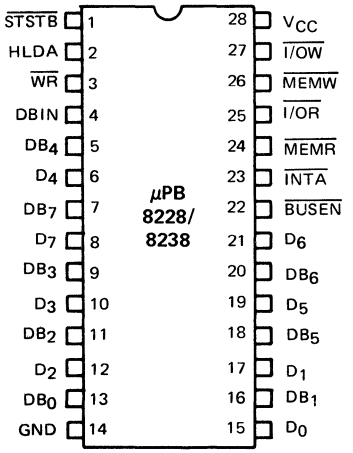
The system controller portion of the μPB8228/8238 consists of a status latch for definition of processor machine cycles and a gating array to decode this information for direct interface to system components. The controller can enable gating of a multi-byte interrupt onto the data bus or can automatically insert a RESTART 7 onto the data bus without any additional components.

Two devices are provided: the μPB8228 for small systems without tight write timing constraints and the μPB8238 for larger systems.

FEATURES

- System Controller for 8080A Systems
- Bi-Directional Data Bus for Processor Isolation
- 3.60V Output High Voltage for Direct Interface to 8080A Processor
- Three State Outputs on System Data Bus
- Enables Use of Multi-Byte Interrupt Instructions
- Generates RST 7 Interrupt Instruction
- μPB8228 for Small Memory Systems
- μPB8238 for Large Memory Systems
- Reduces System Package Count
- Schottky Bipolar Technology

PIN CONFIGURATION



NC: No Connection

PIN NAMES

$D_7 - D_0$	Data Bus (Processor Side)
$DB_7 - DB_0$	Data Bus (System Side)
$\overline{I/OR}$	I/O Read
$\overline{I/OW}$	I/O Write
$\overline{MEMR}$	Memory Read
$\overline{MEMW}$	Memory Write
$\overline{DBIN}$	DBIN (From Processor)
$\overline{INTA}$	Interrupt Acknowledge
HLDA	HLDA (From Processor)
$\overline{WR}$	WR (From Processor)
$\overline{BUSEN}$	Bus Enable Input
$\overline{STSTB}$	Status Strobe (From μPB8224)
V_{CC}	+5V
GND	0 Volts

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FUNCTIONAL DESCRIPTION

Bi-Directional Bus Driver

The eight bit, bi-directional bus driver provides buffering between the processor data bus and the system data bus. On the processor side, the μPB8228/8238 exceeds the minimum input voltage requirements (3.0V) of the μPD8080A. On the system side, the driver is capable of adequate drive current (10 mA) for connection of a large number of memory and I/O devices to the bus. Signal flow in the bus driver is controlled by the gating array and its outputs can be forced into a high impedance state by use of the $\overline{\text{BUSEN}}$ input.

Status Latch

The Status Latch in the μPB8228/8238 stores the status information placed on the data bus by the 8080A at the beginning of each machine cycle. The information is latched when $\overline{\text{STSTB}}$ goes low and is then decoded by the gating array for the generation of control signals.

Gating Array

The Gating Array generates "active low" control signals for direct interfacing to system components by gating the contents of the status latch with control signals from the 8080A.

$\overline{\text{MEM/R}}$, $\overline{\text{I/OR}}$ and $\overline{\text{INTA}}$ are generated by gating the DBIN signal from the processor with the contents of the status latch. $\overline{\text{I/OR}}$ is used to enable an I/O input onto the system data bus. $\overline{\text{MEM/R}}$ is used to enable a memory input.

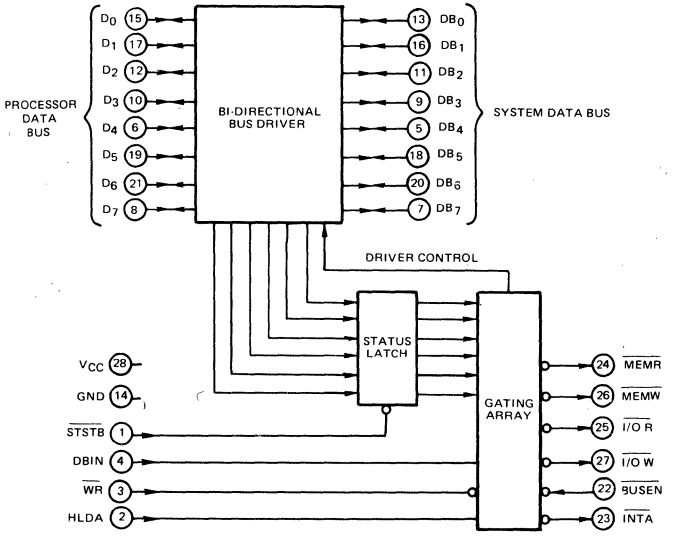
$\overline{\text{INTA}}$ is normally used to gate an interrupt instruction onto the system data bus. When used with the μPD8080A processor, the μPB8228/8238 will decode an interrupt acknowledge status word during all three machine cycles for a multi-byte interrupt instruction. For 8080A type processors that do not generate an interrupt acknowledge status word during the second and third machine cycles of a multi-byte interrupt instruction, the μPB8228/8238 will internally generate an $\overline{\text{INTA}}$ pulse for those machine cycles.

The μPB8228/8238 also provides the designer the ability to place a single interrupt instruction onto the bus without adding additional components. By connecting the +12 volt supply to the $\overline{\text{INTA}}$ output (pin 23) of the μPB8228/8238 through a 1 K ohm series resistor, RESTART 7 will be gated onto the processor data bus when DBIN is active during an interrupt acknowledge machine cycle.

$\overline{\text{MEM/W}}$ and $\overline{\text{I/OW}}$ are generated by gating the $\overline{\text{WR}}$ signal from the processor with the contents of the status latch. $\overline{\text{I/OW}}$ indicates that an output port write is about to occur. $\overline{\text{MEM/W}}$ indicates that a memory write will occur.

The data bus output buffers and control signal buffers can be asynchronously forced into a high impedance state by placing a high on the $\overline{\text{BUSEN}}$ pin of the μPB8228/8238. Normal operation is performed with $\overline{\text{BUSEN}}$ low.

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS*

Operating Temperature	0°C to +70°C
Storage Temperature	−65°C to +150°C
All Output or Supply Voltages	−0.5 to +7 Volts
All Input Voltages	−1.5 to 5.5 Volts
Output Currents	100 mA

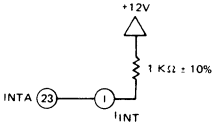
COMMENT: Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

*T_a = 25°C

DC CHARACTERISTICS

T_a = 0°C to 70°C, V_{CC} = 5V ± 5%

PARAMETER	SYMBOL	LIMITS MIN	LIMITS TYP	LIMITS MAX	UNIT	TEST CONDITIONS
Input Clamp Voltage, All Inputs	V_C			-1.0	V	V_{CC} = 4.75V; I_{CC} = −5 mA
Input Load Current, $\overline{STSTB}$	I_F			500	μA	V_{CC} = 5.25V, V_F = 0.45V
D_2 and D_6				750	μA	
D_0, D_1, D_4, D_5, and D_7				250	μA	
All Other Inputs				250	μA	
Input Leakage Current, $\overline{STSTB}$	I_R			100	μA	V_{CC} = 5.25V, V_R = 5.0V
DB_0 through DB_7				20	μA	
All Other Inputs				100	μA	
Input Threshold Voltage, All Inputs	V_{TH}	0.8		2.0	V	V_{CC} = 5V
Power Supply Current	I_{CC}			190	mA	V_{CC} = 5.25V
Output Low Voltage, D_0 through D_7	V_{OL}			0.45	V	V_{CC} = 4.75V; I_{OL} = 2 mA
All Other Outputs				0.48	V	I_{OL} = 10 mA
Output High Voltage, D_0 through D_7	V_{OH}	3.6			V	V_{CC} = 4.75V; I_{OH} = −10 μA
All Other Outputs		2.4			V	I_{OH} = −1 mA
Short Circuit Current, All Outputs	I_{OS}	15		90	mA	V_{CC} = 5V
Off State Output Current, All Control Outputs	$I_{O(off)}$			100	μA	V_{CC} = 5.25V; V_O = 5.0V
				-100	μA	V_O = 0.45V
INTA Current	I_{INT}			5	mA	(See Figure below)



INTA TEST CIRCUIT

CAPACITANCE,

T_a = 25°C

PARAMETER	SYMBOL	LIMITS MIN	LIMITS TYP	LIMITS MAX	UNIT	TEST CONDITIONS
Input Capacitance	C_{IN}			12	pF	V_{BIAS} = 2.5V, V_{CC} = 5.0V, f = 1 MHz
Output Capacitance Control Signals	C_{OUT}			15	pF	
I/O Capacitance (D or DB)	$C_{I/O}$			15	pF	

NOTE: This parameter is periodically sampled and not 100% tested.

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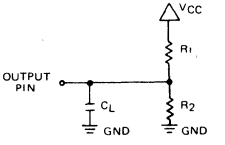
AC CHARACTERISTICS

T_a = 0°C to 70°C, V_{CC} = 5V ± 5%

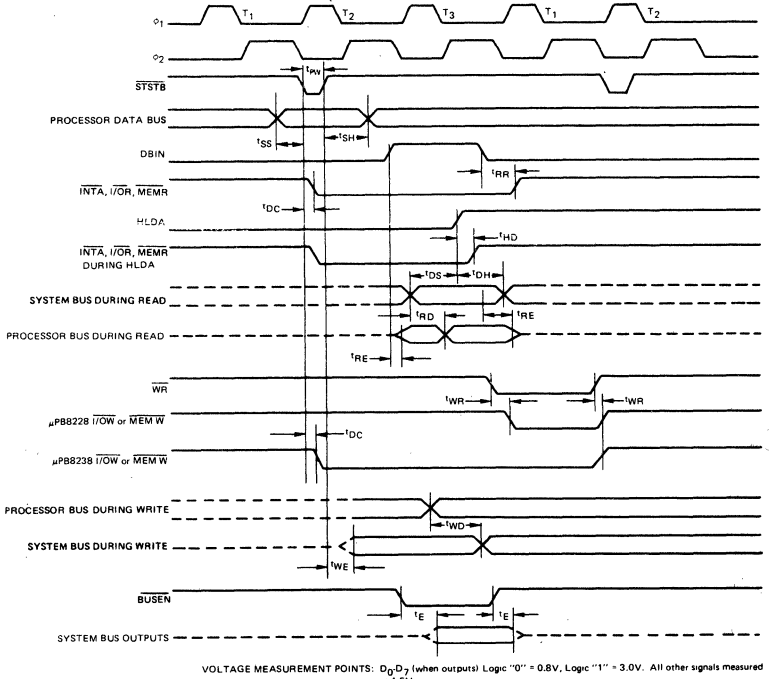
PARAMETER	SYMBOL	LIMITS MIN	LIMITS TYP	LIMITS MAX	UNIT	TEST CONDITIONS
Width of Status Strobe	t_{PW}	22			ns	
Setup Time, Status Inputs D_0-D_7	t_{SS}	8			ns	
Hold Time, Status Inputs D_0-D_7	t_{SH}	5			ns	
Delay from $\overline{STSTB}$ to any Control Signal	t_{DC}	20		60	ns	C_L = 100 pF
Delay from DBIN to Control Outputs	t_{RR}			30	ns	C_L = 100 pF
Delay from DBIN to Enable/ Disable 8080A Bus	t_{RE}			45	ns	C_L = 25 pF
Delay from System Bus to 8080A Bus during Read	t_{RD}			30	ns	C_L = 25 pF
Delay from $\overline{WR}$ to Control Outputs	t_{WR}	5		45	ns	C_L = 100 pF
Delay to Enable System Bus DB_0-DB_7 after $\overline{STSTB}$	t_{WE}			30	ns	C_L = 100 pF
Delay from 8080A Bus D_0-D_7 to System Bus DB_0-DB_7 during Write	t_{WD}	5		40	ns	C_L = 100 pF
Delay from $\overline{System\ Bus\ Enable}$ to System Bus DB_0-DB_7	t_E			30	ns	C_L = 100 pF
HLDA to Read Status Outputs	t_{HD}			25	ns	
Setup Time, System Bus Inputs to HLDA	t_{DS}	10			ns	
Hold Time, System Bus Inputs to HLDA	t_{DH}	20			ns	C_L = 100 pF

For D_0-D_7: R_1 = 4 KΩ, R_2 = ∞Ω,
C_L = 25 pF. For all other outputs:
R_1 = 500Ω, R_2 = 1 KΩ, C_L = 100 pF.



TEST CIRCUIT

TIMING WAVEFORMS



VOLTAGE MEASUREMENT POINTS: D_0-D_7 (when outputs) Logic "0" = 0.8V, Logic "1" = 3.0V. All other signals measured at 1.5V.

STATUS WORD CHART

DATA BUS BIT	STATUS INFORMATION	INSTRUCTION FETCH	MEMORY READ	MEMORY WRITE	STACK READ	STACK WRITE	INPUT READ	OUTPUT WRITE	INTERRUPT ACKNOWLEDGE (M_1)	INT. ACK. (M_2, M_3)	HALT ACKNOWLEDGE	
		(1)	(2)	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)	
D_0	INTA	0	0	0	0	0	0	0	1	0	1	μPD8080A OUTPUT
D_1	$\overline{WO}$	1	1	0	1	0	1	0	1	1	1	
D_2	STACK	0	0	0	1	1	0	0	0	0	0	
D_3	HLTA	0	0	0	0	0	0	0	0	1	1	
D_4	OUT	0	0	0	0	0	0	1	0	0	0	
D_5	M_1	1	0	0	0	0	0	0	1	0	1	
D_6	INP	0	0	0	0	0	1	0	0	0	0	
D_7	MEMR	1	1	0	1	0	0	0	0	1	0	
24	$\overline{MEMR}$	0	0	1	0	1	1	1	1	1	1	μPB8228/8238 OUTPUT
26	$\overline{MEMW}$	1	1	0	1	0	1	1	1	1	1	
25	$\overline{I/OR}$	1	1	1	1	1	0	1	1	1	1	
27	$\overline{I/OW}$	1	1	1	1	1	1	0	1	1	1	
23	$\overline{INTA}$	1	1	1	1	1	1	1	0	0	1	
PIN NO.		SIGNAL STATUS										
		μPB8228/8238 CONTROL SIGNALS										

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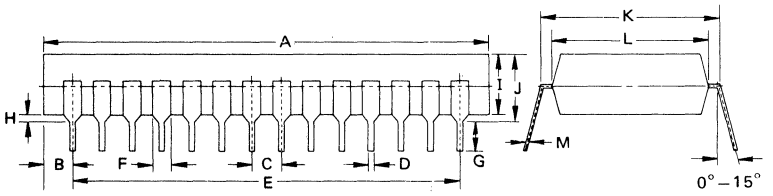
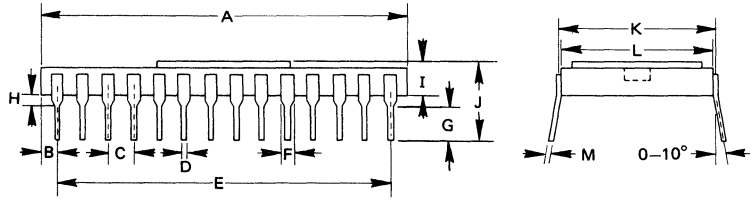
PACKAGE OUTLINE
μPB8228C
μPB8238C



(Plastic)

ITEM	MILLIMETERS	INCHES
A	38.0 MAX.	1.496 MAX.
B	2.49	0.098
C	2.54	0.10
D	0 5 ± 0.1	0.02 ± 0.004
E	33.02	1.3
F	1.5	0.059
G	2.54 MIN.	0.10 MIN.
H	0.5 MIN.	0.02 MIN.
I	5.22 MAX.	0.205 MAX.
J	5.72 MAX.	0.225 MAX.
K	15.24	0.6
L	13.2	0.52
M	$0.25^{+0.10}_{-0.05}$	$0.01^{+0.004}_{-0.002}$

μPB8228D
μPB8238D



(Ceramic)

ITEM	MILLIMETERS	INCHES
A	36.2 MAX.	1.43
B	1.59 MAX.	0.06
C	2.54	0.1
D	0.46 ± 0.05	0.02 ± 0.004
E	33.02	1.3
F	1.02	0.04
G	3.2 MIN.	0.13
H	1.0	0.04
I	3.5	0.14
J	4.5	0.18
K	15.24	0.6
L	14.93	0.59
M	0.25 ± 0.05	0.01 ± 0.002